

C1206C474K5NACAUTO

SMD Auto X8L HT150C, Ceramic, 0.47 uF, 10%, 50 VDC, X8L, SMD, MLCC, High Temperature, Temperature Stable, Automotive Grade, 1206



Click here for the 3D model.

Dimensions		
Chip Size	1206	
L	3.2mm +/-0.2mm	
W	1.6mm +/-0.2mm	
Т	1.6mm +/-0.15mm	
В	0.5mm +/-0.25mm	

Packaging Specifications		
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	2000	

General Information	
Series	SMD Auto X8L HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Temperature Stable, Automotive Grade
Features	High Temperature, Temperature Stable, Automotive Grade
RoHS	Yes
Termination	Tin
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Component Weight	41 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.47 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	X8L
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	+15%/-40%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	1.0638 GOhms

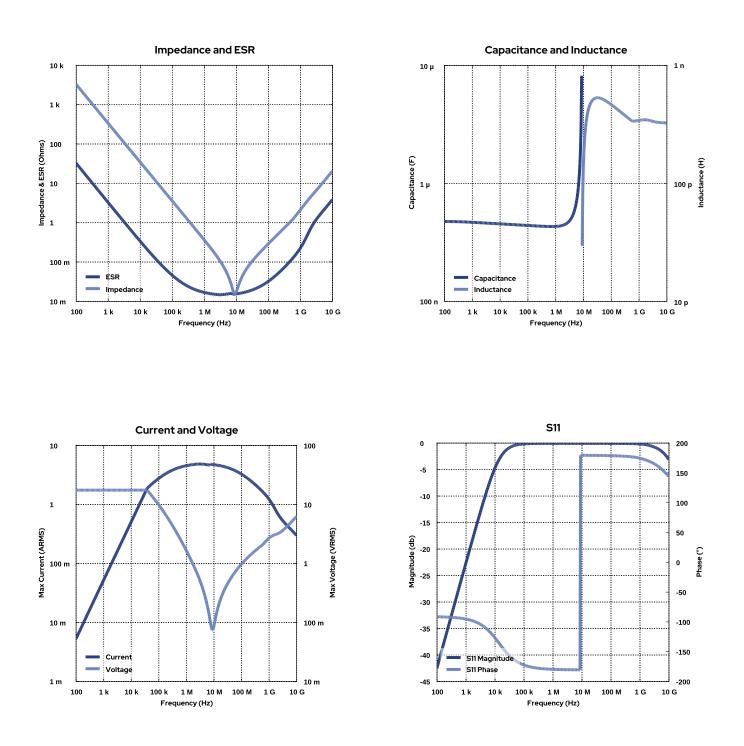
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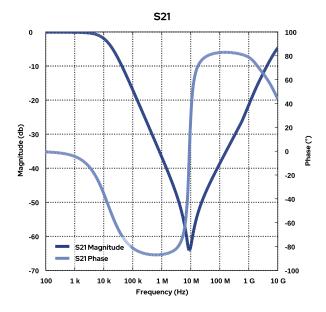
Simulations

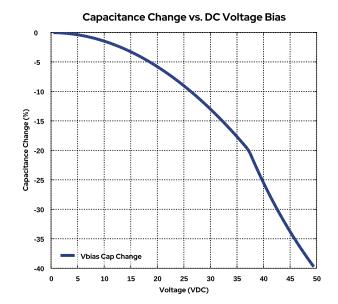
For the complete simulation environment please visit K-SIM.





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Capacitance Change versus Temperature 8 6 4 Capacitance Change (%) 2 0 -2 -4 Temp Cap Change -6 -50 100 -100 0 50 150 Temperature (C)

Capacitance Change versus AC Voltage 4 3 2 Capacitance Change (%) 1 0 -1 -2 VCAC Cap Change -3 0.5 1.5 2 2.5 0 1 Voltage (VAC)



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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance. The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other
- harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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